

DESCRIPTION

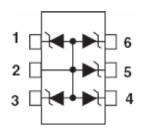
The ESDA6V1W6 is a monolithic suppressor designed to protect components connected to data and transmission lines against ESD. The device clamp the voltage just above the logic level supply for positive transients, and to a diode drop below ground for negative transients.

The ESDA6V1W6 is available in SC-88 package.

ORDERING INFORMATION

Package Type	Part Number			
SC-88	ESDA6V1W6-1			
Note	Package Q'ty/Reel			
Note	1=3,000pcs/Reel			
AiT provides all RoHS Compliant Products				

PIN DESCRIPTION



FEATURES

- 5 Unidirectional Transil functions
- Breakdown voltage:
- $V_{BR} = 6.1V \text{ min.}$ and 25V min.
- Low leakage current: < 1mA
- Very small PCB area < 4.2 mm2 typically
- High ESD protection level: up to 25kV
- High integration

Complies with the following standards

IEC61000-4-2

Level 4 15kV (air discharge)

9kV(contact discharge)

MIL STD 883E - Method 3015-7 Class 3

25kV HBM (Human Body Model)

Available in SC-88 package

APPLICATIONS

- Computers
- Printers
- Communication systems
- Cellular phones handsets and accessories
- Wired and wireless telephone sets
- Set top boxes

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ABSOLUTE MAXIMUM RATINGS

T_{amb} = 25°C

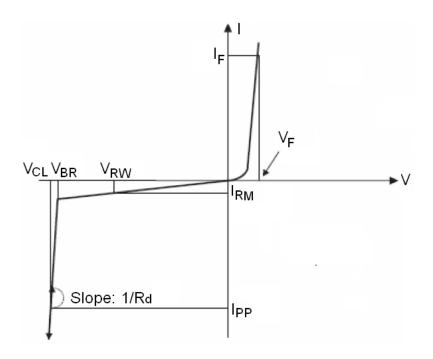
P _{PP} , Peak Pulse Power (t _p = 8/20µs)	100W		
T _L , Maximum lead temperature for soldering during 10s	260°C		
T _{stg} , Storage Temperature Range	-40°C to +125°C		
T _{op} , Operating Temperature Range	-40°C to +125°C		

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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ELECTRICAL PARAMETER



Symbol	Parameter			
V _{RM}	Stand-off voltage			
V_{BR}	Breakdown voltage			
VcL	Clamping voltage			
I _{RM}	Leakage current			
I _{PP}	Peak pulse current			
I _R	Reverse current			
lF	Forward current			
αΤ	Voltage temperature coefficient			
V _F	Forward voltage drop			
С	Capacitance			
R _d	Dynamic			

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ELECTRICAL CHARACTERISTICS

	V _{BR}			V		VF		R₀	αΤ	С
Part Number	MIN	MAX	IR	V _{RM}	IRM	MAX	IF	TYP NOTE1	MAX NOTE2	TYP 0v bias
	٧	٧	mA	٧	μΑ	V	mA	Ω	10 -4 /°C	pF
ESDA6V1W6	6.1	7.2	1	3	1	1.25	200	0.61	6	50

NOTE1: Square pulse I_{PP} = 15A, t_p = 2.5 μ s NOTE2: V_{BR} = aT x (T_{amb} -25°C) x V_{BR} (25°C)

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TYPICAL CHARACTERISTICS

Figure 1. Pulse Width

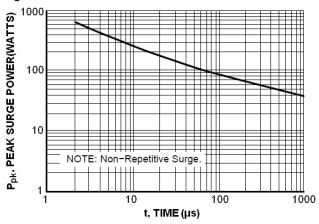


Figure 3. Pulse Derating Curve

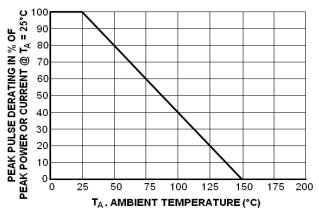


Figure 5. Forward Voltage

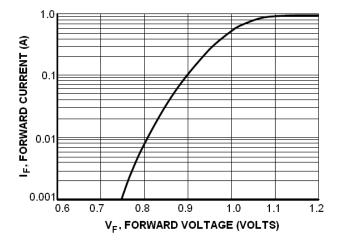


Figure 2. 8 x 20µs Pulse Waveform

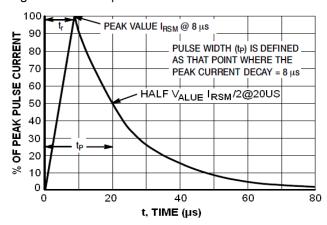


Figure 4. Capacitance

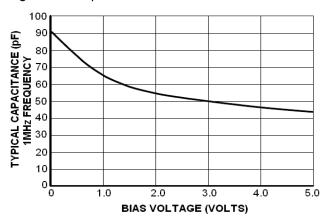
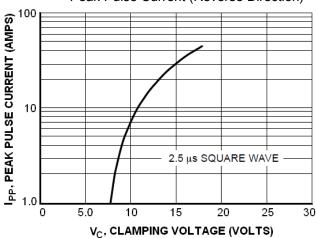
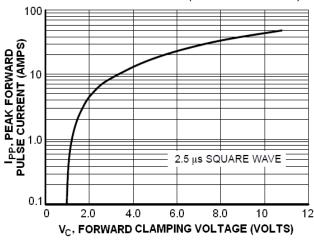


Figure 6. Clamping Voltage versus
Peak Pulse Current (Reverse Direction)



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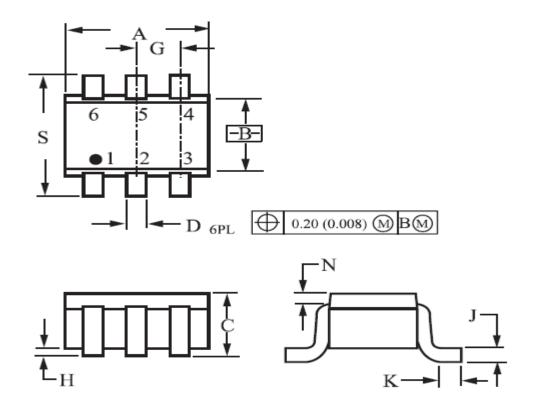
Figure 7. Clamping Voltage versus
Peak Pulse Current (Forward Direction)



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PACKAGE INFORMATION

Dimension in SC-88 Package (Unit: mm)



DIM	INCI	HES	MILLIMETERS		
	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.031	0.043	0.80	1.10	
D	0.004	0.012	0.10	0.30	
G	0.026	BSC	0.65 BSC		
Н	-	0.004	-	0.10	
J	0.004	0.010	0.10	0.25	
K	0.004	0.012	0.10	0.30	
N	0.008	REF	0.20	REF	
S	0.079	0.087	2.00	2.20	

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